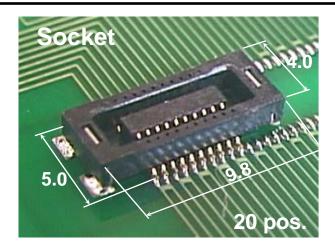
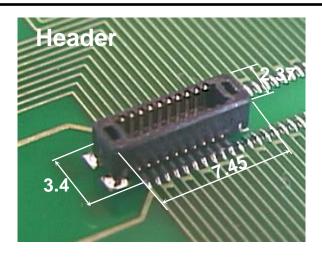
DF29 Series MKT-E-02012F **0.5mm pitch, 2.5mm Stacking Height** Board to Board SMT Connectors



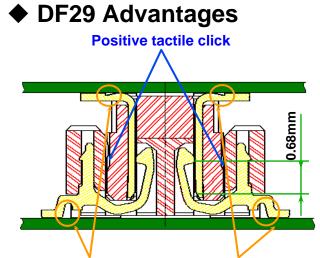


Features

1. Space Saving Design

Socket: approx. 33% reduced, header: approx. 19% reduced in occupied mounting area compared to Hirose's conventional type DF16

- 2. Long Effective Mating Length: 0.68mm
- 3. Tactile Click & Secure Retention Force for mating
- 4. Contact Buckling Prevented Mating Design
- 5. Varieties: 2.5mm stacking height 20, 40 pos. available
 - 2.0mm stacking height 60pos. under development



Current Capacity	0.3A
Rated Voltage	50V AC
Operating Temperature	–35°C to +85°C*
Contact Retention Force	1.5N Min. per pin
Contact Resistance	$60m\Omega$ max. (100mA DC or 1000Hz)
Withstanding Voltage	150V AC, 1 minute
Insulation Resistance	500MΩ min. (100V DC)
Insertion and Withdrawal	50 times Max.

Performance Specifications

Note*: Include the temperature rising by current carrying.

Prevention against solder wicking

Application Examples

Mobile phone, PDA, Digital Still Camera, Digital Video Camera, Bluetooth Module

Specifications herein are subject to change without notice. Contact Hirose for latest specifications, drawings or availabilities.

HIROSE ELECTRIC CO., LTD.